AS	PC SSOCIATION CONNECTING ECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	oarts, the	declaratio	n encompa		r level mate	erials for	which th	e item is an assembly ie manufacturer has leclaration.		
1752-2 1.1 IPC Web Site for Information on IF http://www.ipc.org/IPC-175x					C-1752 Standard						aration Class * s 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat						
Sup	plier Information																
Cor	npany Name *		Company Unique ID		Unique ID Au	Response Date *			Res	Response Document ID							
SEMTECH CORPORATION 00-84			00-847-9941		DUNS	UNS											
Contact Name * T		Title - Contact		Phone - Contact *			Email - Contact *				0 1 1	A (1					
ROYA READER			Quality Customer Se	ervice Spec	(805) 389-2742		rreader@semtech.com				Duplicate	Contact	-> Autho	rized Re	presentative		
Authorized Representative * Title		Title - Representative	е	Phone - Representative *		Email - Representative *		* Sup	Supplier Comments or URL for Additional Information								
		Quality Customer Service Spec (805) 389-2742					eader@semtech.com										
Requester Item Number		r	Mfr Item Number		Mfr Item Name		Effective Date Version		Version	Manufactu	ing Site	Weight *	UC	DM	Unit Type		
		SC4215HSETRT		Very Low Inp		put / Very Low Drop		Philip		Philippine	pines 78		mg	1	Each		
	Alternate Recommendation							Alternate Item Co			ents						
Ма	nufacturing Proces	ss In	formation								·						
Terminal Plating / Grid Array Material		al	Terminal Base Alloy		J-STD-020 MSL Ra	ting Peak Process Boo		ess Body	Temperatur	re Max Time at Peak Temperature			Number of Reflow Cycles				
Matte Tin (Sn) Comments			CU Alloy	oy 1				:	260 C		30 seconds		3				
	1215HSETRT is a REA	ACH-	compliant product,	per EU Re	gulation EC1	1907/2006 to inclu	ide rec	ent addit	ion of S	VHC cand	date list of	substance	s in Dec	ember 2	2012.		

Save the fields in this form to a file	Export Data	Import fields from a file into this form	Import Data	Clear all of the fields on this form	Reset Form	Lock the fields on this form to prevent chan	Look Cumption Fields
RoHS Material	Composition Declara	tion				Declaration Type	* Detailed
		limit of 0.1% by mass (100 thers (PBDE) and quantity	, .				ominated Biphenyls (PBB),
chromium, polybrominate excess of an applicable of gathered the information Company will rely on this completing this form, and certifications regarding the conditions of that agreen	ed biphenyls and/or polybrominated quantity limit, please indicate below it provides in this form using approp certification in determining the com I that Supplier may not have independent rein contributions to the part, and the nent, including any warranty rights a	which, if any, RoHS exemption you b priate methods to ensure its accuracy apliance of its products with European andently verified such information. Ho pose certifications are at least as comp	icted substance") in excess believe may apply. If the p y and that such information n Union member state laws bowever, in situations where prehensive as the certification that agreement, will be the s	of the applicable quantity limit bart is an assembly with lower I is true and correct to the best of that implement the RoHS Dire Supplier has not independentl on in this paragraph. If the Co ole and exclusive source of the	identified above. If a homogene- evel components, the declaration of its knowledge and belief, as of ctive. Company acknowledges to y verified information provided by mpany and the Supplier enter into a Supplier's liability and the Comp	eous material within the part cont n shall encompass all such comp f the date that Supplier complete that Supplier may have relied on y others, Supplier agrees that, at to a written agreement with response upany's remedies for issues that a	tains a RoHS restricted substance in ponents. Supplier certifies that it s this form. Supplier acknowledges that
RoHS Declaration	n * 1 - Item(s) does not contain	RoHS restricted substances per th	he definition above			Supplier Acceptance *	Accepted
	declared item does not cont Il applicable exemptions.	ain RoHS restricted substanc	es per the definition a	bove except for defined	RoHS exemptions, then s	select the corresponding re	esponse in the RoHS Declaration
Declaration Si	gnature						
		C 1 1 11 C (1 1)			· • • • • •	T 1: 10 11 1 4	D' i ll i

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Homogeneous Material Composition Declaration for Electronic Products

Subltem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Exempt	Weight	Unit of	Tolerance		PPM
	Name		Material	Weight	Measure			oubstance oategory			oubstance		Exempt	Weight	Measure	-	+	
+ -	SILICON CHIP	+M -M	Silicon Die	3.25	mg	+C -C	Supplier		+S	-S	Silicon (Si)	7440-21-3		3.25	mg			41,849
+I -I	LEAD FRAME, SOIC	+M -M	CDA194	9.44	mg	+C -C	Supplier		+S	Ş	Copper (Cu)	7440-50-8		9.204	mg			118,51
									+S	-s	Iron (Fe)	7439-89-6		0.22184	mg			2,856.5
									+S	-s	Zinc (Zn)	7440-66-6		0.011328	mg			145.87
									+S	-s	Phosphorous (P)	7723-14-0		0.002832	mg			36.47
+I -I	DIE ATTACH MATE	+M -M	2600AT	1.73	mg	+C -C	Supplier		+S	-S	Silver (Ag)	7440-22-4		1.38	mg			17,821
									+S	-s	Epoxy Resin	Proprietary		0.13	mg			1,670.7
									+S	-s	n-paraffinic HydroCarbo	Proprietary		0.13	mg			1,670.7
									+S	-s	Hot melt adhesive	Proprietary		0.087	mg			1,113.8
+I -I	WIRE BONDING	+M -M	Gold Wire	8.09	mg	+C -C	Supplier		+S	-S	Gold (Au)	7440-57-5		8.09	mg			104,16
+I -I	MOLDING COMPOL	+M -M	EME-G600	46.71	mg	+C -C	Supplier		+S	-S	Silica Fused	606076-86-0		41	mg			526,28
									+S	-s	Epoxy Resin	129915-35-1		2.3	mg			30,073
									+S	-s	Epoxy, Cresol Novolac	29690-82-2		0.934	mg			12,029
									+S	-s	Phenol Resin	9003-35-4		2.34	mg			30,073
									+S	-s	Carbon Black	1333-86-4		0.23	mg			30,073
+I -I	PLATING - TIN	+M -M	Tin (Sn)	8.4	mg	+C -C	Supplier		+S	-S	Tin (Sn)	7440-31-5		8.4	mg			108,67